

### **Founding Member**





## Cell Projection to Extend Shaped-Beam-Litho for New Applications

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### Cell Projection Early E-Beam Idea for New Applications Today



IBM, 1979



Source: H. C. Pfeiffer, IEEE Trans. Electron. Devices ED-26, 663, 1979 (Vistec), 1993



Source: Elsner, Hahmann, J. Vac. Sci. Technol. B, Vol. 11, No. 6, Nov/Dec 1993 Source: eBeam Initiative Website ebeam.org, Features Archive

eBeam Initiative, 2009

Available today and uniquely effective at and below 65-nm

Fast EbDW using CP

ELECTRON GUN

1<sup>ST</sup> - APERTURE

2<sup>ND</sup> - APERTURE

DEMAGNIFICATION

(A) VSB: Variable Shaped Beam

Drawing Courtesy Hitachi High-Technologies

Beam

(B) CP: Character or Cell Projection

#### Applications, 2024





Source: Fraunhofer IOF, Jena / Germany

### Variable Shaped Beam (VSB)





### electron beam

shaping deflection

positioning deflection

substrate

### Variable Shaped Beam Writing





## VSB and Cell Projection Seamlessly Integrated in the Same Hardware (switch electro-optically)





### VSB and Cell Projection Seamlessly Integrated in the Same Hardware (switch electro-optically)







### 2 Tool Types: Both Shaped Beam + Cell Projection









SB250 up to 200 mm wafer up to 7 inch mask SB3050

up to 300 mm wafer up to 9 inch mask

### Cell Projection Hardware: Etched Mini-Reticle on Stencil-Chip on Piezo-Stage



mini-reticle etched into silicon membrane



multi **stencil chip more than 10.000 reticles** (depending on size)

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fully automatic **reticle positioning** short range: by E-Beam deflection long range: by piezo stage positioning







- Complete toolbox available in Vistec's propriatary ePLACE data preparation system.
- Seamlessly integrated with Variable Shaped Beam inluding all corrections.
- NEW: Exact Mathematical Function instead of layout can be used to create exposure data to prevent vertice artifacts when fracturing a layout.

3 Ways to do Cell Projection Data Preparation ...



### Data Prep: Way 1: Create Layout out of existing Mini-Reticles

Layout and marking boxes



Cells are marked in yellow

Layout is hierarchical and consists of Mini Reticles as basic cells.

## Data Prep: Way 2: Use Marking Boxes to support Cell Fracturing



# Layout (slanted gratings) Marking boxes Fractured Data (JES) **MR-Lib** +**ePLACE**

Cells are marked in yellow VSB shots in green

Layout may be non-hierarchical. No pre-cuts to MR size are required.

2024-02-27

### Data Prep: Way 3: Identify Cell Candidates in Arbitrary Layouts





### ePLACE

offers tools to identify Mini Reticle candidates

### Data Prep: Continuous CD Tuning of Cells by Dose







**CD-SEM** measurement

82.71 nm 101.00 nm 120.55 nm 137.76 nm



## Data Prep: Curvilinear features





### Application Example 1: Effective Medium Blazed Grating









Source: Fraunhofer IOF, Jena / Germany

## Application Example 2: High Quality Any Angle Gratings





## Application Example 3: Metamaterials: Small Structures + High Fidelity + Large Areas





### **Plasmonic Nanostructures**

Bow Tie & Spiral Arrays

Source: IPHT Jena, Germany



- Cell- or Character Projection has a long E-Beam history in different flavours.
- Vistec's solution is fully automated and seamlessly integrated with Variable Shaped Beam.
- Sophisticated and proven Hard- and Software is available, like more than 10.000+ mini reticles and appropriate Data Prep tools.
- Cell Projection increases throughput AS WELL AS pattern fidelity.
- Cell Projection fits especially optics and photonics mastering applications.



# Thank you for your attention !

### and the whole Vistec team for its contributions.





#### Publisher

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Cell Projection to extend Shaped-Beam Litho for new applications / eBeam Initiative Luncheon @ SPIE-AL